

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chris Stapelmann	11/12/2007
Thomas Schulz	11/06/2007
RECEIVING PARTY DATA	
Name:	Infineon Technologies AG
Street Address:	Am Campeon 1-12
City:	Neubiberg
State/Country:	GERMANY
Postal Code:	85579
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11934665
CORRESPONDENCE DATA	
Fax Number:	(972)732-9218
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	972-732-1001
Email:	clark@slater-matsil.com
Correspondent Name:	Slater & Matsil, L.L.P.
Address Line 1:	17950 Preston Rd.
Address Line 2:	Suite 1000
Address Line 4:	Dallas, TEXAS 75252
ATTORNEY DOCKET NUMBER:	INF 2007 P 51752 US
NAME OF SUBMITTER:	Kimberley Clark
<p>Total Attachments: 4</p> <p>source=07P51752_Assignment#page1.tif</p> <p>source=07P51752_Assignment#page2.tif</p>	

CH \$40.00 11934665

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PATENT
REEL: 020548 FRAME: 0380

ASSIGNMENT

For good and valuable consideration, I, **Chris Stapelmann**, residing at Steenbakkerijlaan 6, 3080 Tervuren, Belgium, a citizen of Germany; **Thomas Schulz**, residing at Jachthorenstraat 2/102, 3001, Heverlee, Belgium, a citizen of Germany;

hereby sell, assign, and transfer to **Infineon Technologies AG**, a corporation organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, 85579 Neubiberg, Germany;

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

Method for Fabricating a Fin-Shaped Semiconductor Structure and a Fin-Shaped Semiconductor Structure

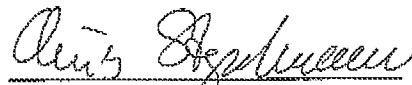
and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and

the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 12 - Nov - 2007


Chris Stoppelmann

Date: _____

Thomas Schulz

ASSIGNMENT

For good and valuable consideration, I, **Chris Stapelmann**, residing at Steenbakkerijlaan 6, 3080 Tervuren, Belgium, a citizen of Germany; **Thomas Schulz**, residing at Jachthorenstraat 2/102, 3001, Heverlee, Belgium, a citizen of Germany;

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Method for Fabricating a Fin-Shaped Semiconductor Structure and a Fin-Shaped Semiconductor Structure

and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and

the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: _____

Chris Stapelmann

Date: 6th Nov. 2007

Thomas Schulz
Thomas Schulz